

International Conference on Planarization/CMP Technology

ICPT 2026

October 19-22, 2026

Science and Technology Convention Center,
Seoul, South Korea

Sponsorship Prospectus

Organized by



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Seoul, South Korea

I. INVITATION TO SPONSORSHIP & EXHIBITION

Shape the Future of Semiconductor CMP at ICPT 2026

We are honored to invite your company to participate as a premier sponsor for The 21st International Conference on Planarization/CMP Technology (ICPT 2026), taking place from October 19th to 22nd, 2026, at the Science and Technology Convention Center in Seoul, South Korea.

For over two decades, ICPT has served as the global cornerstone for sharing groundbreaking advancements in CMP and planarization technologies. This year, we anticipate welcoming over 500 industry leaders, renowned researchers, and technical experts from around the world to the heart of the semiconductor industry, Seoul.

Why Sponsor ICPT 2026?

Sponsoring ICPT 2026 is more than a branding opportunity; it is a strategic investment to position your organization at the forefront of the industry. As a sponsor, you will gain exclusive access to a highly targeted audience and enjoy distinct benefits designed to maximize your ROI:

- **Thought Leadership:** Deliver an exclusive keynote address to the entire assembly.
- **Prime Visibility:** Secure priority selection for exhibition booths and premium exposure across the venue.
- **Targeted Networking:** Engage directly with key decision-makers and potential clients through our structured networking sessions.

We offer a diverse range of sponsorship packages – from Diamond to Silver – tailored to meet your marketing and business objectives. We look forward to partnering with you to make ICPT 2026 a resounding success.

II. Conference Information

Title	International Conference on Planarization/CMP Technology (ICPT 2026)
Date	October 19 (Mon.) – 22 (Thu.), 2026
Place	Science and Technology Convention Center, Seoul, South Korea
Organized by	International Conference on Planarization/CMP Technology (ICPT) Korea Chemical Mechanical Planarization Users Group Meeting (CMPUGM) Korean Association for Particle and Aerosol Research (KAPAR)
Programs	Welcome Reception, Opening Ceremony, Banquet, Keynote Speeches, Oral & Poster Sessions, Exhibition
Scale	- About 250 presentations - About 500~600 participants from 10 countries and regions
Website	https://www.icpt2026.org/

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III. Important Dates

Abstract Submission Deadline	May 31, 2026
Notification of Abstract Acceptance	July 3, 2026
Early Bird Registration Deadline	August 31, 2026

IV. Conference Topics

ICPT 2026 offers a premier platform for global academic researchers, industry professionals, and engineers to share the latest advancements in Chemical Mechanical Polishing (CMP) and other planarization technologies.

We invite abstracts of original work covering a range of topics related to planarization, including:

01. Advanced Interconnect CMP (Metal)
02. Dielectric & Hard materials CMP
03. Advanced Packaging / 3D Integration CMP (Hybrid Cu Bonding, BSPDN, Wafer Thinning)
04. Post-CMP Cleaning / Defect Engineering
05. AI & ML for CMP / Process Control
06. Metrology & Inspection / Equipment / Process Diagnostics
07. CMP Consumables (Slurry, Abrasive, Pad, Conditioner, Filter etc.,)
08. CMP Fundamentals (Tribology, Multiphysics Modeling etc.,)
09. Nanomaterials & Surface Engineering for CMP
10. Sustainable CMP / Manufacturing Readiness

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V. Sponsorship Information

We cordially introduce special opportunities for your company.

Your sponsorship in this exciting event will provide excellent opportunities for your company to expose high quality products and services to the experts from all parts of the world.

Sponsorship Guideline

- To secure your booking and to ensure you gain the best possible promotional location, please fill out the Sponsorship Application form and e-mail it to the ICPT 2026 Secretariat (icpt2026@icpt2026.org) with a copy of business registration certificate.
- All sponsorship categories are filled **on first-come, first-served basis**.

Application Deadline

- The deadline for the application is **July 31, 2026**.

Cancellation Policy

- Before July 31, 2026: 100% of full payment will be refunded.
- Before August 31, 2026: 50% of full payment will be refunded.
- From September 1, 2026: Full payment will not be refunded.
- Cancellation of Sponsorship must be made in written format to the secretariat via e-mail.

ICPT 2026**October 19-22, 2026**Science and Technology Convention Center,
Seoul, South Korea**Sponsorship Type**

Benefits		1. Diamond	2. Platinum	3. Gold	4. Silver	5. Banquet Host
		USD 25,000	USD 15,000	USD 10,000	USD 7,500	Approx. USD 30,000
Complimentary Standard Conference Registrations		5 Persons	3 Persons	2 Persons	1 Person	Benefits and payment are subject to prior consultation with the Secretariat.
Complimentary Exhibition Booth (2 m x 2 m)		3 Booths (Priority Selection)	2 Booths (Second Selection)	1 Booths (Third Selection)	1 Booth	
Advertisement on the Program Book		1 Page	1 Page	1 Page	1/2 Page	
On-Stage Exposure		Exclusive Luncheon Keynote Speech (10 min.)	X	X	X	
Play the Promotional Movie on a Large TV		Mini-Movie (60 sec.) Advertisement in Conference Area	Mini-Movie (30 sec.) Advertisement in Conference Area	X	X	
Receive Conference Attendee Contact List*		O	O	O	O	
Logo Printing	Program Book	O	O	O	O	
	Screen at Session Room	O	O	O	O	
Web Banner (Logo + Link)	Official Website	O	O	O	O	
	E-Newsletter	O	O	O	O	

** Conference attendees must opt-in to share contact information with sponsors/exhibitors.

[Exhibition Booth Provided Items]

- Exhibition booth (including signage and lighting)
- 1 Desk
- 2 Chairs
- Basic Electricity: Single-phase 220 V, 2-outlet power strip

** If additional power is required beyond the basic provision, a separate usage fee will be charged.

** ICPT 2026 exhibition is only available as part of the sponsorship benefits.



※ Depending on the situation, the booth design may change.

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Sponsorship Application Form

Please fill out the below application form, and send it back to the secretariat.

ICPT 2026 Secretariat**E-mail: icpt2026@icpt2026.org / Tel: +82-42-472-7460**

1. Company Information

Company Name			
Address			
President			
Contact Person Name		Job Title / Department	
Telephone		Mobile	
E-mail			

2. Sponsorship Application

Sponsorship Type	USD	Apply (Check "O")
Diamond	USD 25,000	
Platinum	USD 15,000	
Gold	USD 10,000	
Silver	USD 7,500	
Banquet Host	Subject to discussion	

3. Account Information (Wire Transfer Only)

- Account Holder: GENICOM CO., LTD. ICPT 2026
- Account Number: 661-910023-71105
- Bank Name: KEB HANA BANK
- SWIFT Code: KOEXKRSE
- Bank Address: 35, EULJI-RO, JUNG-GU, SEOUL, SOUTH KOREA
- Sponsorship Application Deadline: July 31, 2026

Name of Applicant: _____ Date: _____

Signature: _____